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Attorney Docket no: SEL 156 DIV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Shunpei Yamazaki et al.

Serial No.: 09/874,670

Filed: June 5, 2001

For: Semiconductor Device And
Manufacturing Method Thereof

Examiner:

Art Unit: 2826

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Date: July 5, 2001

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Washington D.C. 20231

PRELIMINARY AMENDMENT A

Prior to examination, please enter the following amendment in the above-identified application.

IN THE CLAIMS:

Please cancel Claims ~~1-26~~ ⁷⁻¹⁷.

Please add the following new claims:

¹⁸
--27. A semiconductor device comprising:

a substrate;

at least one pixel electrode formed over said substrate;

at least one thin film transistor formed over said substrate for switching said pixel electrode,

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